9-146462-0 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 9-146462-0 PCB Mount Header, Vertical, Board-to-Board, 40 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU Headers

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **40**

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Unshrouded

Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
Configuration Features				
Stackable	Yes			
PCB Mount Orientation	Vertical			
Number of Positions	40			
Number of Rows	1			
Board-to-Board Configuration	Parallel			
Electrical Characteristics				
Insulation Resistance	5000 MΩ			
Body Features				
Primary Product Color	Black			
Contact Features				
Contact Mating Area Length	8.38 mm[.33 in]			
Mating Square Post Dimension	.64 mm[.025 in]			

C For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 40 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU Headers



	100 – 200 µin	
Contact Layout	Inline	
Contact Shape & Form	Square	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Copper Alloy	
Contact Mating Area Plating Material	Gold	
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]	
Contact Type	Pin	
Contact Current Rating (Max)	3 A	
Termination Features		
Square Termination Post & Tail Dimension	.64 mm[.025 in]	
Termination Post & Tail Length	2.77 mm[.109 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Alignment	Without	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	Thermoplastic	
Dimensions		
Stack Height	7.62 mm[.3 in]	
PCB Thickness (Recommended)	1.4 mm[.055 in]	
Usage Conditions		
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]	
Operation/Application		
Circuit Application	Signal	
Industry Standards		
Approved Standards	CSA LE7189, UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		

C For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 40 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU Headers



Packaging Quantity	125
Packaging Type	Carton
Product Compliance	
For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023
	(235)
	Candidate List Declared Against: JUNE 2023 (235)
	Does not contain REACH SVHC
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900
	ppm per homogenous material. Also BFR
	/CFR/PVC Free
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



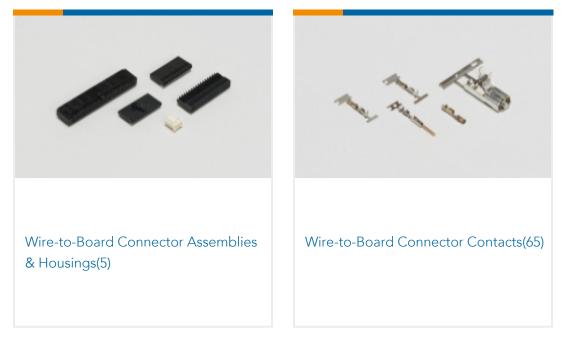
Also in the Series AMPMODU Headers

C For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 40 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU Headers



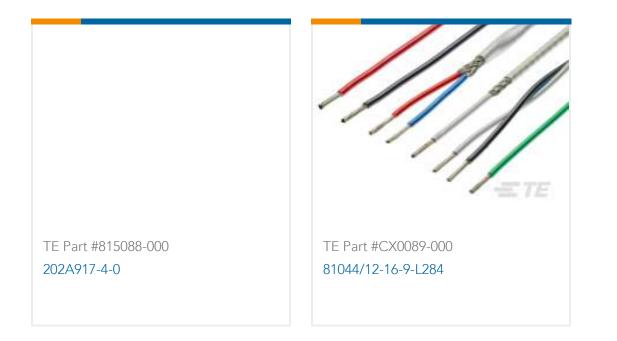




Customers Also Bought



TE Part #5-103166-2 08 MODII HDR DRRA SHRD LF	TE Part #2-1437565-9 FSM2JSMAATR=TACTILE 260G FORCE	TE Part #2337245-4 TACT MINI JB 5.2X5.2X2 260GF	TE Part #2176378-5 RQ 0805 11R 0.1% 10PPM 5K RL
	ETE	2	TE
TE Part #5-2176380-7 RQ 0805 4K42 0.1% 10PPM 5K RL	TE Part #8-2176388-1 RQ 1206 68R1 0.1% 10PPM 5K RL	TE Part #36149 PIDG R 22-16 COMM 22-18 MIL 6	TE Part #1658939-3 SFP 1X6 CAGE & LIGHT PIPE KIT



Documents

PCB Mount Header, Vertical, Board-to-Board, 40 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU Headers



Product Drawings 40 MODII HDR SRST UNSHRD STKG

English

Datasheets & Catalog Pages AMPMODU Interconnetion System

AMPMODU Interconnetion System

English